

THC63LVD104C

112MHz 30Bits COLOR LVDS Receiver

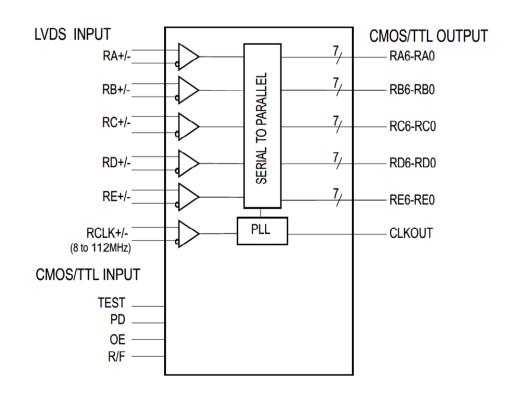
General Description

The THC63LVD104C receiver is designed to support pixel data transmission between Host and Flat Panel Display from NTSC up to SXGA resolutions. The THC63LVD104C converts the LVDS data streams back into 35bits of CMOS/TTL data with the choice of the rising edge or falling edge clock for the convenience with a variety of LCD panel controllers. At a transmit clock frequency of 112MHz, 30bits of RGB data and 5bits of timing and control data (HSYNC, VSYNC,DE,CNTL1,CNTL2) are transmitted at an effective rate of 784Mbps per LVDS channel. Using a 112MHz clock, the data throughput is 490Mbytes per second

Features

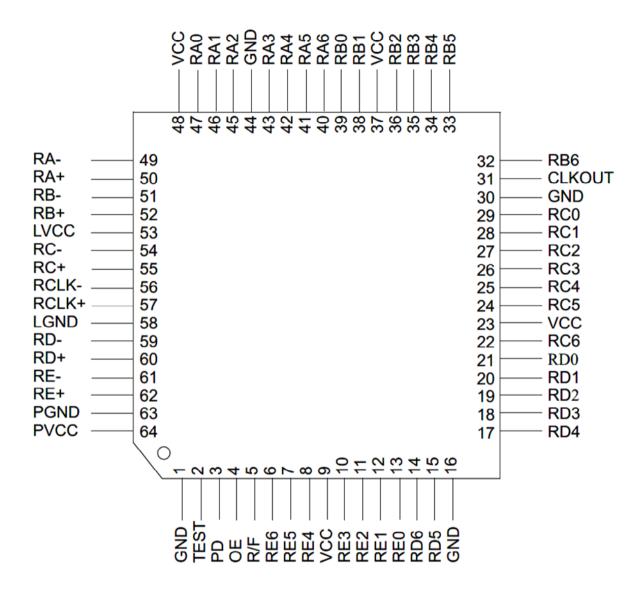
- Wide dot clock range: 8-112MHz suited for NTSC, VGA, SVGA, XGA, and SXGA
- PLL requires no external components
- 50% output clock duty cycle
- TTL clock edge programmable
- Power down mode
- Low power single 3.3V CMOS design
- 64pin TQFP
- Backward compatible with THC63LVDF64x (18bits) / F84x(24bits)
- Pin compatible with THC63LVD104A
- Fail-safe for Open LVDS Input

Block Diagram





Pin Diagram





Pin Name	Pin #	Туре	Description		
RA+. RA-	50. 49	LVDS IN			
RB+, RB-	52, 51	LVDS IN	_		
RC+, RC-	55, 54	LVDS IN	LVDS Data In.		
RD+, RD-	60, 59	LVDS IN			
RE+,RE-	62, 61	LVDS IN			
RCLK+, RCLK-	57, 56	LVDS IN	LVDS Clock In.		
RA6 ~ RA0	40,41,42,43,45,46,47	OUT			
RB6 ~ RB0	32,33,34,35,36,38,39	OUT			
RC6 ~ RC0	22,24,25,26,27,28,29	OUT	CMOS/TTL Data Outputs.		
RD6 ~ RD0	14,15,17,18,19,20,21	OUT			
RE6 ~ RE0	6,7,8,10,11,12,13	OUT			
TEST	2	IN	Test pin, must be "L" for normal operation.		
			H: Normal operation,		
PD	3	IN	L: Power down (all outputs are "L")		
OE	4	IN	H: Output enable (Normal operation). L: Output disable(all outputs are Hi-Z)		
R/F	5	IN	Output Clock Triggering Edge Select. H: Rising edge, L: Falling edge		
VCC	9,23,37,48	Power	Power Supply Pins for TTL outputs and digital circuitry.		
CLKOUT	31	OUT	Clock out.		
GND	1,16,30,44	Ground	Ground Pins for TTL outputs and digital circuitry.		
LVCC	53	Power	Power Supply Pin for LVDS inputs.		
LGND	58	Ground	Ground Pin for LVDS inputs.		
PVCC	64	Power	Power Supply Pin for PLL circuitry.		
PGND	63	Ground	Ground Pin for PLL circuitry.		

PD	R/F	OE	Data Outputs (Rxn)	CLKOUT
0	0	0	Hi-Z	Hi-Z
0	0	1	All 0	Fixed Low
0	1	0	Hi-Z	Hi-Z
0	1	1	All 0	Fixed Low
1	0	0	Hi-Z	Hi-Z
1	0	1	Data Out	The falling edge closer to the center of the data eye.
1	1	0	Hi-Z	Hi-Z
1	1	1	Data Out	The rising edge closer to the center of the data eye.

** Rxn

x = A, B, C, D, E

n = 0,1,2,3,4,5,6



Absolute	Maximum	Ratings	*1
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-0.3V ~ +4.0V
-0.3V ~ (Vcc + 0.3V)
-0.3V ~ (Vcc + 0.3V)
-0.3V ~ (Vcc + 0.3V)
-30mA ~ 30mA
+125 °C
-55 ° C ~ +150 °C
+260 ° C / 10sec.
2.1W

Electrical Characteristics

CMOS/TTL DC Specifications

	-	VCC =LVCC=PVCC= 3.0V ~ 3.6V, Ta = -20° C~ +85°C				
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Viн	High Level Input Voltage	-	2.0	-	Vcc	V
VIL	Low Level Input Voltage	-	GND	-	0.8	V
Vон	High Level Output Voltage	IOH= -4mA (data) IOH= -8mA (clock)	2.4	-	-	V
Vol	Low Level Output Voltage	IOL= 4mA (data) IOL= 8mA (clock)	-	-	0.4	V
linc	Input Current	ΟΥ δ VIN δ Vcc	-		±10	μΑ

LVDS Receiver DC Specifications

		VCC =LVCC=PVCC= 3.0V ~ 3.6V, Ta = -20° C~ +85°					
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units	
Vтн	Differential Input High Threshold	VIC= 1.2V	_	_	100	mV	
Vtl	Differential Input Low Threshold	VIC= 1.2V	-100	-	-	mV	
linl	Input Current	VIN= 2.4V / 0V VCC= 3.6V	-		30	μΑ	

1. "Absolute Maximum Ratings" are those values beyond which the safety of the device can not be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.



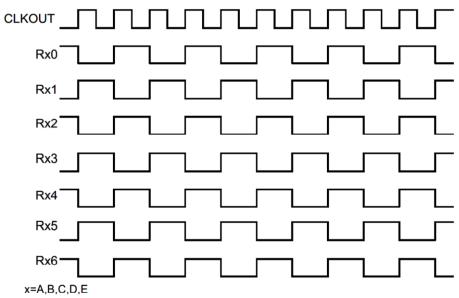
Supply Current

VCC =LVCC=PVCC= 3.0V ~ 3.6V, Ta = -20° C~ +85°C

Symbol	Parameter	Conditions	Тур.	Max.	Units	
	Receiver Supply	fclkout = 75MHz fclkout = 90MHz	CL=8pF,Vcc=3.6V, Ta= -20 ° C ~ 85 °C	-	205 236	mA mA
IRCCW	Current (LVDS Full Toggle)	fclkout = 112MHz	CL=8pF,Vcc=3.6V, Ta= -20 ° C ~70 °C *	-	280	mA
IRCCS	Receiver Power Down Supply Current	PD = L		-	25	μA

*The trade-off between the output load and the ambient temperature exists so that the junction temperature does not exceed 125°C.

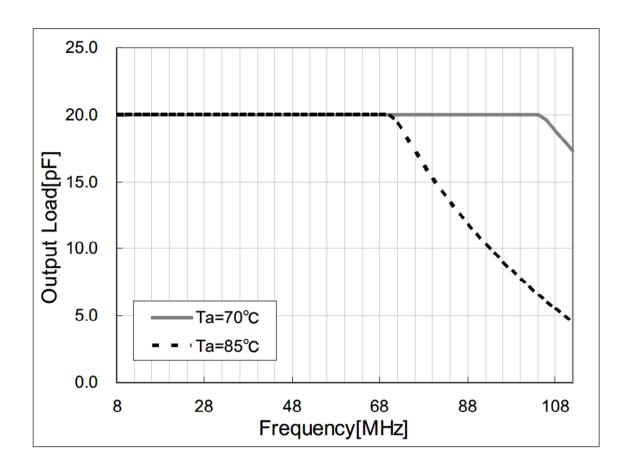
LVDS Full Toggle Pattern





Output load limitation

The output load is limited so that the junction temperature does not exceed 125°C.





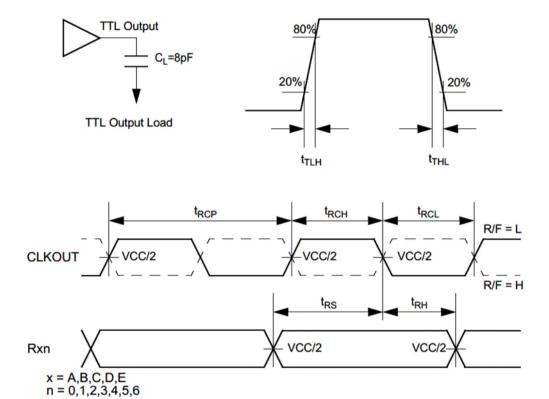
Switching Characteristics

Symbol	Parameter	Min.	Тур.	Max.	Units
tRCP	CLKOUT Period	8.92	Т	125.0	ns
trch	CLKOUT High Time	-	T/2	-	ns
tRCL	CLKOUT Low Time	-	T/2	-	ns
trs	TTL Data Setup to CLKOUT	4/7t _{RCP} -1	-	-	ns
trh	TTL Data Hold from CLKOUT	3/7t _{RCP} -1	-	_	ns
t⊤LH	TTL Low to High Transition Time	-	1.0	3.0	ns
t⊤н∟	TTL High to Low Transition Time	-	1.0	3.0	ns
	CLKOUT=50MHz	-1000	0	1000	ps
	Receiver SkewCLKOUT=75MHz	-550	0	550	ps
ISK	Margin CLKOUT=90MHz	-400	0	400	ps
	CLKOUT=112MHz	-250	0	250	ps
trip1	Input Data Position0	-t _{SK}	0	+tsĸ	ns
trip0	Input Data Position1	T/7-tsĸ	Т/7	T/7+tsĸ	ns
tRIP6	Input Data Position2	2Т/7-t _{SK}	2T/7	2Т/7+t _{sк}	ns
trip5	Input Data Position3	3T/7-tsк	3T/7	3T/7+tsк	ns
tRIP4	Input Data Position4	4T/7-tsк	4T/7	4T/7+t _{sк}	ns
trip3	Input Data Position5	5T/7-tsĸ	5T/7	5Т/7+tsк	ns
tRIP2	Input Data Position6	6Т/7-t _{SK}	6T/7	6Т/7+t _{sк}	ns
tRPLL	Phase Lock Loop Set	-	-	10.0	ms
tRCD	RCLK +/- to CLKOUT Delay	46.5	-	52.5	ns
trcip	CLKIN Period	8.92	-	125.0	ns



Switching Characteristics

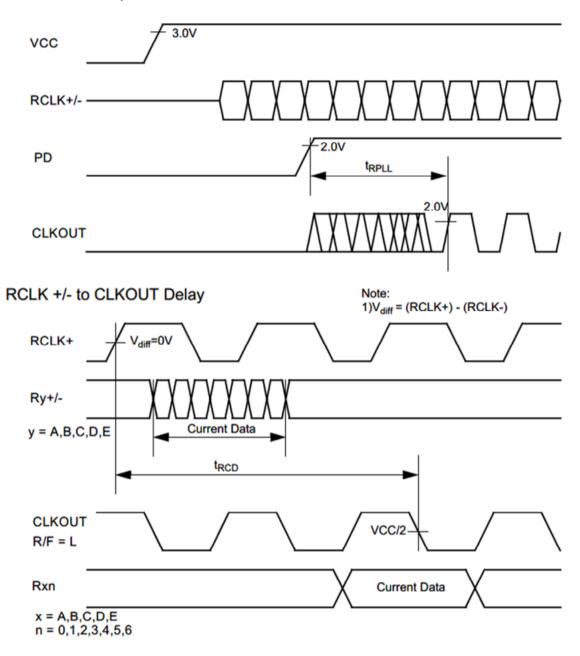
TTL Outputs





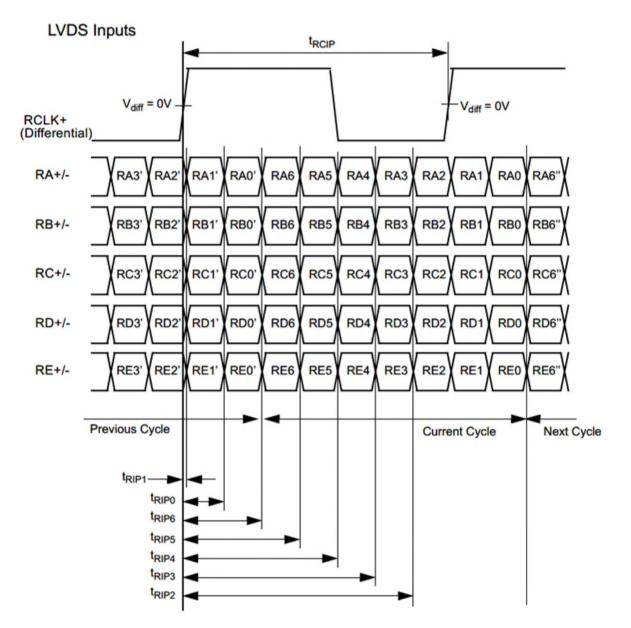
AC Timing Diagram

Phase Lock Loop Set Time





AC Timing Diagram





Note

1)Power On Sequence Power on LVDS-Tx after THC63LVD104C.

2)Cable Connection and Disconnection

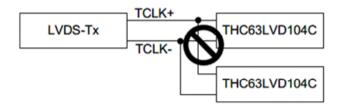
Don't connect and disconnect the LVDS cable, when the power is supplied to the system.

3)GND Connection

Connect the each GND of the PCB which LVDS-Tx and THC63LVD104C on it. It is better for EMI reduction to place GND cable as close to LVDS cable as possible.

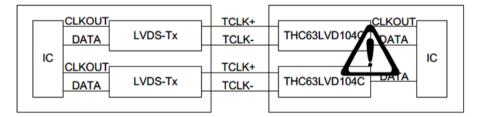
4)Multi Drop Connection

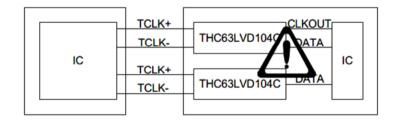
Multi drop connection is not recommended.



5)Asynchronous use

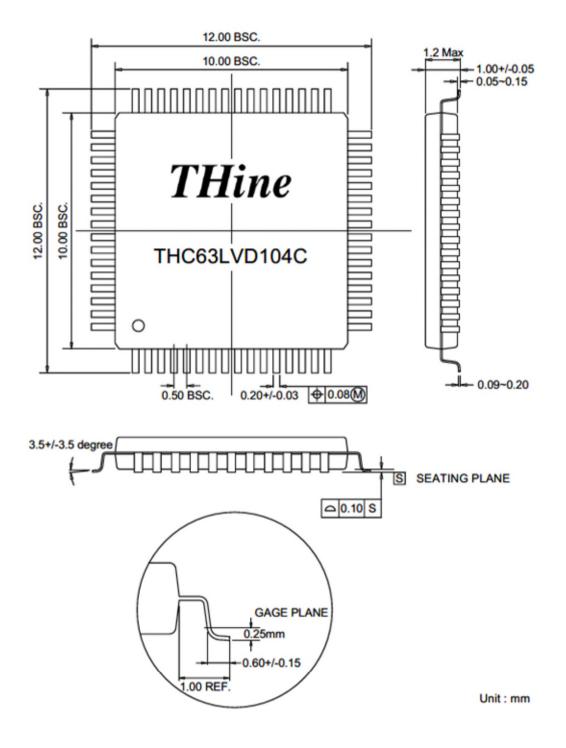
Asynchronous use such as following systems are not recommended.







Package





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